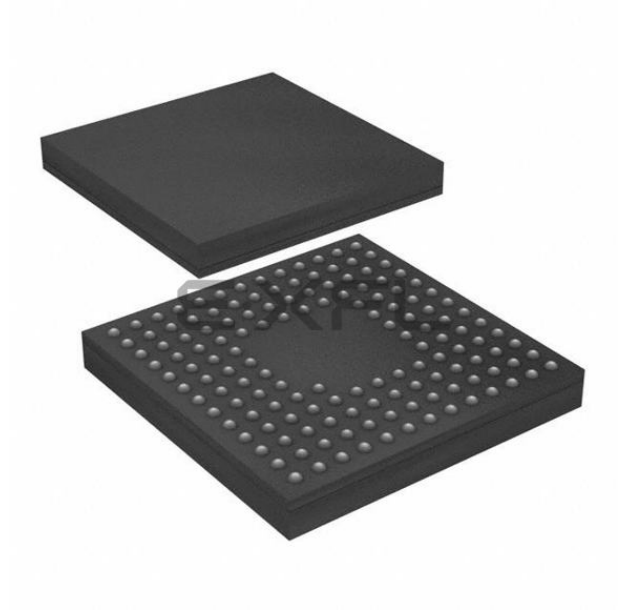
Renesas Electronics America Inc - R5F565NCDDLK#20 Datasheet



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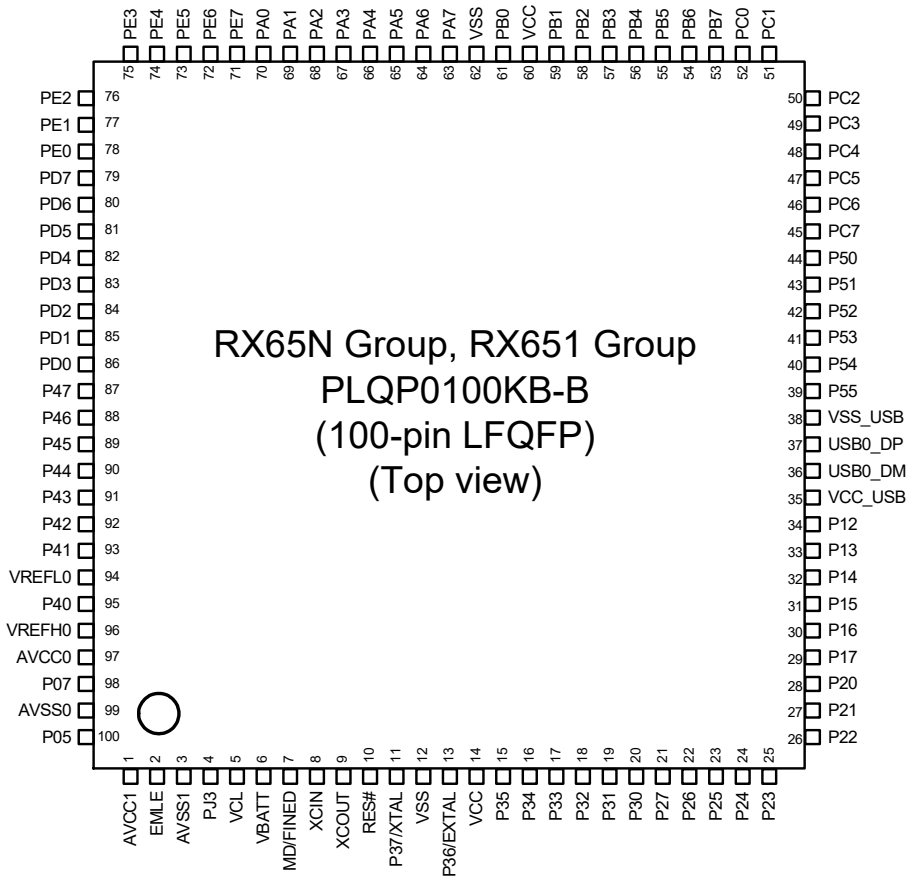
Applications of "Embedded - Microcontrollers"

Details	
Product Status	Active
Core Processor	RXv2
Core Size	32-Bit Single-Core
Speed	120MHz
Connectivity	CANbus, EBI/EMI, Ethernet, I²C, LINbus, MMC/SD, QSPI, SCI, SPI, UART/USART, USB
Peripherals	DMA, LVD, POR, PWM, WDT
Number of I/O	111
Program Memory Size	1.5MB (1.5M x 8)
Program Memory Type	FLASH
EEPROM Size	32K x 8
RAM Size	640K x 8
Voltage - Supply (Vcc/Vdd)	2.7V ~ 3.6V
Data Converters	A/D 29x12b; D/A 2x12b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	145-TFLGA
Supplier Device Package	145-TFLGA (7x7)
Purchase URL	https://www.e-xfl.com/product-detail/renesas-electronics-america/r5f565ncddlk-20

Table 1.1 Outline of Specifications (5/9)

Classification	Module/Function	Description
Timers	8-bit timers (TMRb)	• (8 bits × 2 channels) × 2 units • Select from among seven internal clock signals (PCLKB/1, PCLKB/2, PCLKB/8, PCLKB/32, PCLKB/64, PCLKB/1024, PCLKB/8192) and one external clock signal • Capable of output of pulse trains with desired duty cycles or of PWM signals • The 2 channels of each unit can be cascaded to create a 16-bit timer • Generation of triggers for A/D converter conversion • Capable of generating baud-rate clocks for SCI5, SCI6, and SCI12 • Event linking by the ELC
	Compare match timer (CMT)	• (16 bits × 2 channels) × 2 units • Select from among four internal clock signals (PCLKB/8, PCLKB/32, PCLKB/128, PCLKB/512) • Event linking by the ELC
	Compare match timer W (CMTW)	• (32 bits × 1 channel) × 2 units • Compare-match, input-capture input, and output-comparison output are available. • Select from among four internal clock signals (PCLKB/8, PCLKB/32, PCLKB/128, PCLKB/512) • Interrupt requests can be output in response to compare-match, input-capture, and output-comparison events. • Event linking by the ELC
	Realtime clock (RTCd)*4	• Clock sources: Main clock, sub clock • Selection of the 32-bit binary count in time count/second unit possible • Clock and calendar functions • Interrupt sources: Alarm interrupt, periodic interrupt, and carry interrupt • Battery backup operation • Time-capture facility for three values • Event linking by the ELC
	Watchdog timer (WDTA)	• 14 bits × 1 channel • Select from among 6 counter-input clock signals (PCLKB/4, PCLKB/64, PCLKB/128, PCLKB/512, PCLKB/2048, PCLKB/8192)
	Independent watchdog timer (IWDTa)	• 14 bits × 1 channel • Counter-input clock: IWDT-dedicated on-chip oscillator • Dedicated clock/1, dedicated clock/16, dedicated clock/32, dedicated clock/64, dedicated clock/128, dedicated clock/256 • Window function: The positions where the window starts and ends are specifiable (the window defines the timing with which refreshing is enabled and disabled). • Event linking by the ELC
Communication function	Ethernet controller (ETHERC)	• Input and output of Ethernet/IEEE 802.3 frames • Transfer at 10 or 100 Mbps • Full- and half-duplex modes • MII (Media Independent Interface) or RMII (Reduced Media Independent Interface) as defined in IEEE 802.3u • Detection of Magic Packets™*1 or output of a “wake-on-LAN” signal (WOL) • Compliance with flow control as defined in IEEE 802.3x standards
	DMA controller for Ethernet controller (EDMACa)	• Alleviation of CPU load by the descriptor control method • Transmission FIFO: 2 Kbytes; Reception FIFO: 2 Kbytes
	USB 2.0 FS host/ function module (USBb)	• Includes a UDC (USB Device Controller) and transceiver for USB 2.0 FS • One port • Compliance with the USB 2.0 specification • Transfer rate: Full speed (12 Mbps), low speed (1.5 Mbps) (host only) • Both self-power mode and bus power are supported • OTG (On the Go) operation is possible (low-speed is not supported) • Incorporates 2 Kbytes of RAM as a transfer buffer • External pull-up and pull-down resistors are not required



Note: This figure indicates the power supply pins and I/O port pins. For the pin configuration, see Table 1.10, List of Pin and Pin Functions (100-Pin LFQFP).

Figure 1.9 Pin Assignment (100-Pin LFQFP)

Table 1.5 List of Pin and Pin Functions (177-Pin TFLGA, 176-Pin LFBGA) (4/8)

Pin Number 177-Pin TFLGA 176-Pin LFBGA	Power Supply Clock System Control	I/O Port	Bus EXDMAC SDRAMC	Timer (MTU, TPU, TMR, PPG, RTC, CMTW, POE, CAC)	Communication (ETHERC, SCI, RSPI, RIIC, CAN, USB)	Memory Interface Camera Interface (QSPI, SDHI, SDSI, MMCIF, PDC)	GLCDC	Interrupt	A/D D/A
H13		PA3	A3	MTIOC0D/ MTCLKD/ TIOCD0/ TCLKB/PO19	ET0_MDIO/ RXD5/SMISO5/ SSCL5		LCD_DATA5-B	IRQ6-DS	
H14		PA2	A2	MTIOC7A/ PO18	RXD5/SMISO5/ SSCL5/SSLA3-B		LCD_DATA6-B		
H15	TRDATA3	PG7	D31						
J1	EXTAL	P36							
J2	VCC								
J3		P34		MTIOC0A/ TMCI3/PO12/ POE10#	ET0_LINKSTA/ SCK6/SCK0			IRQ4	
J4	TMS	PF3							
J12		PA5	A5	MTIOC6B/ TIOCB1/PO21	ET0_LINKSTA/ RSPCKA-B		LCD_DATA3-B		
J13	VSS								
J14		PA7	A7	TIOCB2/PO23	ET0_WOL/ MISOA-B		LCD_DATA1-B		
J15		PA6	A6	MTIC5V/ MTCLKB/ TIOCA2/ TMCI3/PO22/ POE10#	ET0_EXOUT/ CTS5#/RTS5#/ SS5#/MOSIA-B		LCD_DATA2-B		
K1		P33	EDREQ1	MTIOC0D/ TIOCD0/ TMRI3/PO11/ POE4#/ POE11#	RXD6/SMISO6/ SSCL6/RXD0/ SMISO0/SSCL0/ CRX0	PCKO		IRQ3-DS	
K2		P32		MTIOC0C/ TIOCC0/ TMO3/PO10/ RTCIC2/ RTCOUT/ POE0#/ POE10#	TXD6/SMOSI6/ SSDA6/TXD0/ SMOSI0/SSDA0/ CTX0/ USB0_VBUSEN	VSYNC		IRQ2-DS	
K3	TDI	PF2			RXD1/SMISO1/ SSCL1				
K4	TCK	PF1			SCK1				
K12		PB2	A10	TIOCC3/ TCLKC/PO26	ET0_RX_CLK/ REF50CK0/ CTS4#/RTS4#/ SS4#/CTS6#/ RTS6#/SS6#	SDSI_D2-B	LCD_TCON2-B		
K13		P71	A18/CS1#		ET0_MDIO				
K14	VCC								
K15		PB0	A8	MTIC5W/ TIOCA3/PO24	ET0_ERXD1/ RMII0_RXD1/ RXD4/SMISO4/ SSCL4/RXD6/ SMISO6/SSCL6		LCD_DATA0-B	IRQ12	
L1		P31		MTIOC4D/ TMCI2/PO9/ RTCIC1	CTS1#/RTS1#/ SS1#/SSLB0-A			IRQ1-DS	
L2		P30		MTIOC4B/ TMRI3/PO8/ RTCIC0/ POE8#	RXD1/SMISO1/ SSCL1/MISOB-A			IRQ0-DS	
L3	TDO	PF0			TXD1/SMOSI1/ SSDA1				

Table 1.7 List of Pin and Pin Functions (145-Pin TFLGA) (2/7)

Pin Number 145-Pin TFLGA	Power Supply Clock System Control	I/O Port	Bus EXDMAC SDRAMC	Timer (MTU, TPU, TMR, PPG, RTC, CMTW, POE, CAC)	Communication (ETHERC, SCI, RSPI, RIIC, CAN, USB)	Memory Interface Camera Interface (QSPI, SDHI, SDSI, MMCIF, PDC)	GLCDC	Interrupt	A/D D/A
B13		PE4	D12[A12/D12]/D4[A4/D4]*1	MTIOC4D/MTIOC1A/PO28	ET0_ERXD2/SSLB0-B		LCD_DATA12-B*1		AN102
C1	AVSS1								
C2		P02		TMCI1	SCK6			IRQ10	AN120
C3	VREFH0								
C4		P41						IRQ9-DS	AN001
C5		P46						IRQ14-DS	AN006
C6	VSS								
C7		PD1	D1[A1/D1]	MTIOC4B/POE0#	MOSIC-A/CTX0		LCD_DATA23-B*1	IRQ1	AN109
C8		PD3	D3[A3/D3]	MTIOC8D/TOC2/POE8#	RSPCKC-A	QIO3-B/SDHI_D3-B/MMC_D3-B	LCD_DATA21-B*1	IRQ3	AN111
C9		PD7	D7[A7/D7]	MTIC5U/POE0#	SSLC3-A	QMI-B/QIO1-B/SDHI_D1-B/MMC_D1-B	LCD_DATA17-B*1	IRQ7	AN107
C10		P63	CAS#/D2[A2/D2]*1/CS3#						
C11		PE0	D8[A8/D8]/D0[A0/D0]*1	MTIOC3D	SCK12/SSLB1-B	MMC_D4-B	LCD_DATA16-B*1		ANEX0
C12		P70	SDCLK						
C13	VSS								
D1		P00		TMRI0	TXD6/SMOSI6/SSDA6			IRQ8	AN118
D2		PF5						IRQ4	
D3		P03						IRQ11	DA0
D4		P01		TMCI0	RXD6/SMISO6/SSCL6			IRQ9	AN119
D5	VCC								
D6		P93	A19	POE0#	CTS7#/RTS7#/SS7#				AN117
D7		PD5	D5[A5/D5]	MTIC5W/MTIOC8C/POE10#	SSLC1-A	QSPCLK-B/SDHI_CLK-B/MMC_CLK-B	LCD_DATA19-B*1	IRQ5	AN113
D8		P60	CS0#						
D9		P64	WE#/D3[A3/D3]*1/CS4#						
D10		PE7	D15[A15/D15]/D7[A7/D7]*1	MTIOC6A/TOC1	MISOB-B	SDHI_WP/MMC_RES#-B	LCD_DATA9-B*1	IRQ7	AN105
D11	VCC								
D12		PE5	D13[A13/D13]/D5[A5/D5]*1	MTIOC4C/MTIOC2B	ET0_RX_CLK/REF50CK0/RSPCKB-B		LCD_DATA11-B*1	IRQ5	AN103
D13		PE6	D14[A14/D14]/D6[A6/D6]*1	MTIOC6C/TIC1	MOSIB-B	SDHI_CD/MMC_CD-B	LCD_DATA10-B*1	IRQ6	AN104
E1	VSS								
E2	VCL								
E3		PJ5		POE8#	CTS2#/RTS2#/SS2#				

Table 1.7 List of Pin and Pin Functions (145-Pin TFLGA) (4/7)

Pin Number 145-Pin TFLGA	Power Supply Clock System Control	I/O Port	Bus EXDMAC SDRAMC	Timer (MTU, TPU, TMR, PPG, RTC, CMTW, POE, CAC)	Communication (ETHERC, SCI, RSPI, RIIC, CAN, USB)	Memory Interface Camera Interface (QSPI, SDHI, SDSI, MMCIF, PDC)	GLCDC	Interrupt	A/D D/A
H12		PB0	A8	MTIC5W/ TIOCA3/PO24	ET0_ERXD1/ RMII0_RXD1/ RXD4/SMISO4/ SSCL4/RXD6/ SMISO6/SSCL6		LCD_DATA0-B*1	IRQ12	
H13		PA7	A7	TIOCB2/PO23	ET0_WOL/ MISOA-B		LCD_DATA1-B*1		
J1	TRST#	P34		MTIOC0A/ TMCI3/PO12/ POE10#	ET0_LINKSTA/ SCK6/SCK0			IRQ4	
J2		P33	EDREQ1	MTIOC0D/ TIOCD0/ TMRI3/PO11/ POE4#/ POE11#	RXD6/SMISO6/ SSCL6/RXD0/ SMISO0/SSCL0/ CRX0	PCKO		IRQ3-DS	
J3		P32		MTIOC0C/ TIOCC0/ TMO3/PO10/ RTCIC2/ RTCOUT/ POE0#/ POE10#	TXD6/SMOSI6/ SSDA6/TXD0/ SMOSI0/SSDA0/ CTX0/ USB0_VBUSEN	VSYNC		IRQ2-DS	
J4	TDI	P30		MTIOC4B/ TMRI3/PO8/ RTCIC0/ POE8#	RXD1/SMISO1/ SSCL1/MISOB-A			IRQ0-DS	
J10		PB3	A11	MTIOC0A/ MTIOC4A/ TIOCD3/ TCLKD/TMO0/ PO27/POE11#	ET0_RX_ER/ RMII0_RX_ER/ SCK4/SCK6	SDSI_D3-B	LCD_TCON1-B*1		
J11		PB4	A12	TIOCA4/PO28	ET0_TX_EN/ RMII0_TXD_EN/ CTS9#/RTS9#/ SS9#/SS11#/ CTS11#/RTS11#	SDSI_CMD-B	LCD_TCON0-B*1		
J12		PB2	A10	TIOCC3/ TCLKC/PO26	ET0_RX_CLK/ REF50CK0/ CTS4#/RTS4#/ SS4#/CTS6#/ RTS6#/SS6#	SDSI_D2-B	LCD_TCON2-B*1		
J13		PB1	A9	MTIOC0C/ MTIOC4C/ TIOCB3/ TMCI0/PO25	ET0_ERXD0/ RMII0_RXD0/ TXD4/SMOSI4/ SSDA4/TXD6/ SMOSI6/SSDA6		LCD_TCON3-B*1	IRQ4-DS	
K1	TCK	P27	CS7#	MTIOC2B/ TMCI3/PO7	SCK1/RSPCKB-A				
K2	TDO	P26	CS6#	MTIOC2A/ TMO1/PO6	TXD1/SMOSI1/ SSDA1/CTS3#/ RTS3#/SS3#/ MOSIB-A				
K3	TMS	P31		MTIOC4D/ TMCI2/PO9/ RTCIC1	CTS1#/RTS1#/ SS1#/SSLB0-A			IRQ1-DS	
K4		P15		MTIOC0B/ MTCLKB/ TIOCB2/ TCLKB/TMCI2/ PO13	RXD1/SMISO1/ SSCL1/SCK3/ CRX1-DS	PIXD0		IRQ5	
K5	TRDATA2	P54	ALE/ D1[A1/D1]*1/ EDACK0	MTIOC4B/ TMCI1	ET0_LINKSTA/ CTS2#/RTS2#/ SS2#/CTX1				
K6		P53*2	BCLK						

Table 1.7 List of Pin and Pin Functions (145-Pin TFLGA) (5/7)

Pin Number 145-Pin TFLGA	Power Supply Clock System Control	I/O Port	Bus EXDMAC SDRAMC	Timer (MTU, TPU, TMR, PPG, RTC, CMTW, POE, CAC)	Communication (ETHERC, SCI, RSPI, RIIC, CAN, USB)	Memory Interface Camera Interface (QSPI, SDHI, SDSI, MMCIF, PDC)	GLCDC	Interrupt	A/D D/A
K7		P51	WR1#/ BC1#/ WAIT#		SCK2/SSLB2-A				
K8	VCC								
K9	TRDATA0	P80	EDREQ0	MTIOC3B/ PO26	ET0_TX_EN/ RMII0_TXD_EN/ SCK10/RTS10#	QIO2-A/SDHI_WP/ MMC_D2-A			
K10	TRDATA6	P76	CS6#	PO22	ET0_RX_CLK/ REF50CK0/ SMISO11/ SSCL11/RXD11	QSSL-A/ SDHI_CMD-A/ SDSI_CMD-A/ MMC_CMD-A			
K11		PB7	A15	MTIOC3B/ TIOCB5/PO31	ET0_CRS/ RMII0_CRS_DV/ TXD9/SMOSI9/ SSDA9/ SMOSI11/ SSDA11/TXD11	SDSI_D1-B			
K12		PB6	A14	MTIOC3D/ TIOCA5/PO30	ET0_ETXD1/ RMII0_TXD1/ RXD9/SMISO9/ SSCL9/ SMISO11/ SSCL11/RXD11	SDSI_D0-B			
K13		PB5	A13	MTIOC2A/ MTIOC1B/ TIOCB4/ TMRI1/PO29/ POE4#	ET0_ETXD0/ RMII0_TXD0/ SCK9/SCK11	SDSI_CLK-B	LCD_CLK-B*1		
L1		P25	CS5#/ EDACK1	MTIOC4C/ MTCLKB/ TIOCA4/PO5	RXD3/SMISO3/ SSCL3	SDHI_CD/HSYNC			ADTRG0#
L2		P23	EDACK0	MTIOC3D/ MTCLKD/ TIOCD3/PO3	TXD3/SMOSI3/ SSDA3/CTS0#/ RTS0#/SS0#	SDHI_D1-C/PIXD7			
L3		P16		MTIOC3C/ MTIOC3D/ TIOCB1/ TCLKC/TMO2/ PO14/RTCOUT	TXD1/SMOSI1/ SSDA1/RXD3/ SMISO3/SSCL3/ SCL2-DS/ USB0_VBUSEN/ USB0_VBUS/ USB0_OVRCURB			IRQ6	ADTRG0#
L4		P24	CS4#/ EDREQ1	MTIOC4A/ MTCLKA/ TIOCB4/ TMRI1/PO4	SCK3/ USB0_VBUSEN	SDHI_WP/PIXCLK			
L5		P13		MTIOC0B/ TIOCA5/TMO3/ PO13	TXD2/SMOSI2/ SSDA2/ SDA0[FM+]			IRQ3	ADTRG1#
L6		P56	EDACK1	MTIOC3C/ TIOCA1	SCK7*1				
L7		P52	RD#		RXD2/SMISO2/ SSCL2/SSLB3-A				
L8	TRCLK	P83	EDACK1	MTIOC4C	ET0_CRS/ RMII0_CRS_DV/ SCK10/SS10#/ CTS10#				
L9		PC5	D3[A3/D3]*1/ A21/CS2#/ WAIT#	MTIOC3B/ MTCLKD/ TMRI2/PO29	ET0_ETXD2/ SCK8/SCK10/ RSPCKA-A	MMC_D5-A			
L10		PC4	A20/CS3#	MTIOC3D/ MTCLKC/ TMCI1/PO25/ POE0#	ET0_TX_CLK/ SCK5/CTS8#/ RTS8#/SS8#/ SS10#/CTS10#/ RTS10#/SSLA0-A	QMI-A/QIO1-A/ SDHI_D1-A/ SDSI_D1-A/ MMC_D1-A			

Table 1.8 List of Pin and Pin Functions (144-Pin LFQFP) (4/7)

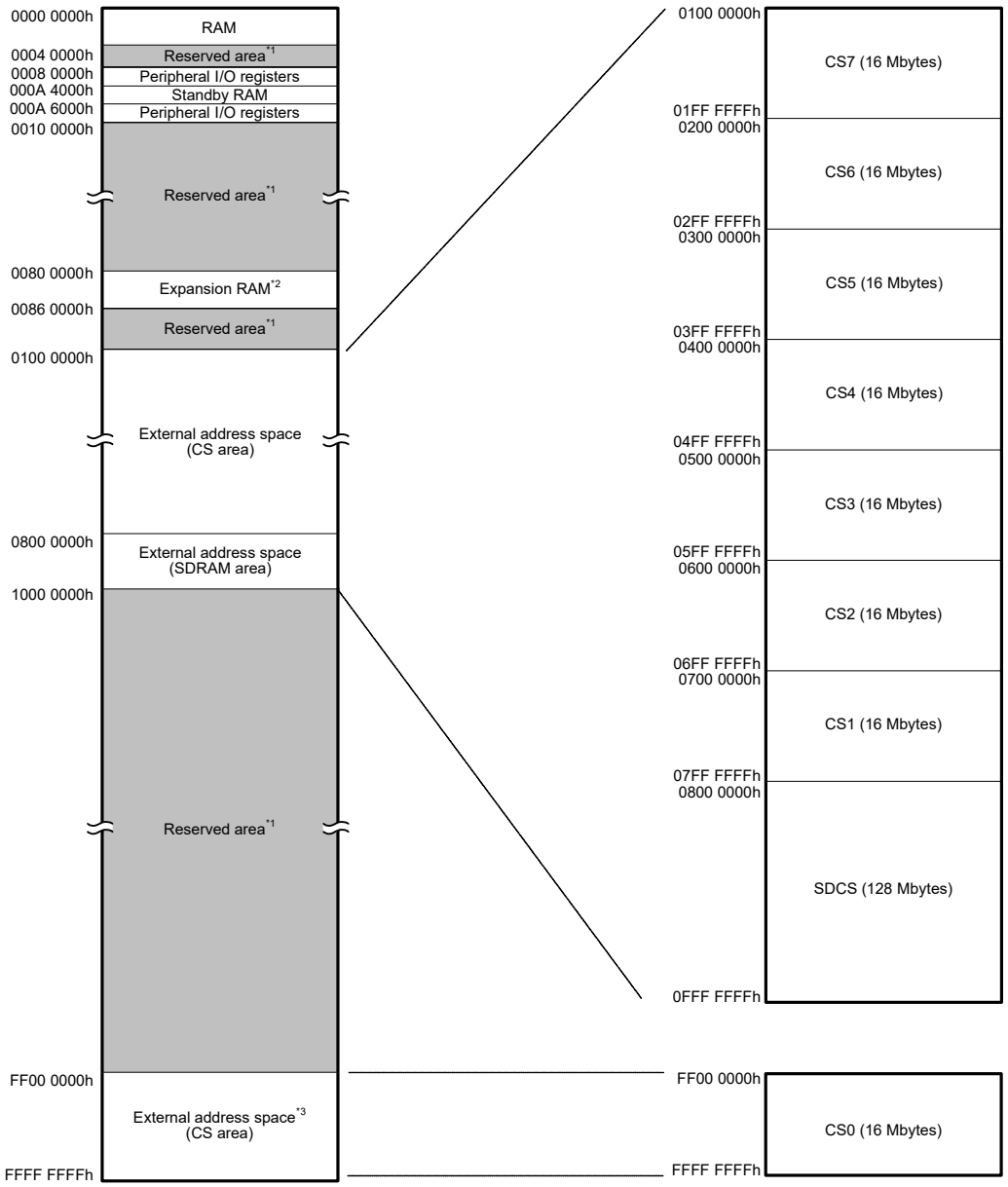
Pin Number 144-Pin LFQFP	Power Supply Clock System Control	I/O Port	Bus EXDMAC SDRAMC	Timer (MTU, TPU, TMR, PPG, RTC, CMTW, POE, CAC)	Communication (ETHERC, SCI, RSPI, RIIC, CAN, USB)	Memory Interface Camera Interface (QSPI, SDHI, SDSI, MMCIF, PDC)	GLCDC	Interrupt	A/D D/A
69	TRDATA6	P76	CS6#	PO22	ET0_RX_CLK/ REF50CK0/ SMISO11/ SSCL11/RXD11	QSSL-A/ SDHI_CMD-A/ SDSI_CMD-A/ MMC_CMD-A			
70		PC2	A18	MTIOC4B/ TCLKA/PO21	ET0_RX_DV/ RXD5/SMISO5/ SSCL5/SSLA3-A	SDHI_D3-A/ SDSI_D3-A/ MMC_CD-A			
71	TRSYNC1	P75	CS5#	PO20	ET0_ERXD0/ RMII0_RXD0/ SCK11/RTS11#	SDHI_D2-A/ SDSI_D2-A/ MMC_RES#-A			
72	TRDATA5	P74	A20/CS4#	PO19	ET0_ERXD1/ RMII0_RXD1/ SS11#/CTS11#				
73		PC1	A17	MTIOC3A/ TCLKD/PO18	ET0_ERXD2/ SCK5/SSLA2-A			IRQ12	
74	VCC								
75		PC0	A16	MTIOC3C/ TCLKC/PO17	ET0_ERXD3/ CTS5#/RTS5#/ SS5#/SSLA1-A			IRQ14	
76	VSS								
77	TRDATA4	P73	CS3#	PO16	ET0_WOL				
78		PB7	A15	MTIOC3B/ TIOCB5/PO31	ET0_CRS/ RMII0_CRS_DV/ TXD9/SMOSI9/ SSDA9/ SMOSI11/ SSDA11/TXD11	SDSI_D1-B			
79		PB6	A14	MTIOC3D/ TIOCA5/PO30	ET0_ETXD1/ RMII0_TXD1/ RXD9/SMISO9/ SSCL9/ SMISO11/ SSCL11/RXD11	SDSI_D0-B			
80		PB5	A13	MTIOC2A/ MTIOC1B/ TIOCB4/ TMRI1/PO29/ POE4#	ET0_ETXD0/ RMII0_TXD0/ SCK9/SCK11	SDSI_CLK-B	LCD_CLK-B*1		
81		PB4	A12	TIOCA4/PO28	ET0_TX_EN/ RMII0_TXD_EN/ CTS9#/RTS9#/ SS9#/SS11#/ CTS11#/RTS11#	SDSI_CMD-B	LCD_TCON0-B*1		
82		PB3	A11	MTIOC0A/ MTIOC4A/ TIOCD3/ TCLKD/TMO0/ PO27/POE11#	ET0_RX_ER/ RMII0_RX_ER/ SCK4/SCK6	SDSI_D3-B	LCD_TCON1-B*1		
83		PB2	A10	TIOCC3/ TCLKC/PO26	ET0_RX_CLK/ REF50CK0/ CTS4#/RTS4#/ SS4#/CTS6#/ RTS6#/SS6#	SDSI_D2-B	LCD_TCON2-B*1		
84		PB1	A9	MTIOC0C/ MTIOC4C/ TIOCB3/ TMCI0/PO25	ET0_ERXD0/ RMII0_RXD0/ TXD4/SMOSI4/ SSDA4/TXD6/ SMOSI6/SSDA6		LCD_TCON3-B*1	IRQ4-DS	
85		P72	A19/CS2#		ET0_MDC				
86		P71	A18/CS1#		ET0_MDIO				

Table 1.9 List of Pin and Pin Functions (100-Pin TFLGA) (2/5)

Pin Number 100-Pin TFLGA	Power Supply Clock System Control	I/O Port	Bus EXDMAC SDRAMC	Timer (MTU, TPU, TMR, PPG, RTC, CMTW, POE, CAC)	Communication (ETHERC, SCI, RSPI, RIIC, CAN, USB)	Memory Interface Camera Interface (QSPI, SDHI, SDSI, MMCIF, PDC)	GLCDC	Interrupt	A/D D/A
C7		PD2	D2[A2/D2]	MTIOC4D/TIC2	MISOC-A/CRX0	QIO2-B/SDHI_D2-B/MMC_D2-B	LCD_DATA22-B*1	IRQ2	AN110
C8		PD5	D5[A5/D5]	MTIC5W/ MTIOC8C/ POE10#	SSLC1-A	QSPCLK-B/ SDHI_CLK-B/ MMC_CLK-B	LCD_DATA19-B*1	IRQ5	AN113
C9		PE5	D13[A13/ D13]/D5[A5/ D5]*1	MTIOC4C/ MTIOC2B	ET0_RX_CLK/ REF50CK0/ RSPCKB-B		LCD_DATA11-B*1	IRQ5	AN103
C10		PE4	D12[A12/ D12]/D4[A4/ D4]*1	MTIOC4D/ MTIOC1A/ PO28	ET0_ERXD2/ SSLB0-B		LCD_DATA12-B*1		AN102
D1	XCIN								
D2	XCOUT								
D3	MD/FINED								
D4	VBATT								
D5		P45						IRQ13-DS	AN005
D6		P46						IRQ14-DS	AN006
D7		PE6	D14[A14/ D14]/D6[A6/ D6]*1	MTIOC6C/TIC1	MOSIB-B	SDHI_CD/ MMC_CD-B	LCD_DATA10-B*1	IRQ6	AN104
D8		PE7	D15[A15/ D15]/D7[A7/ D7]*1	MTIOC6A/ TOC1	MISOB-B	SDHI_WP/ MMC_RES#-B	LCD_DATA9-B*1	IRQ7	AN105
D9		PA1	A1	MTIOC0B/ MTCLKC/ MTIOC7B/ TIOCB0/PO17	ET0_WOL/ SCK5/SSLA2-B		LCD_DATA7-B*1	IRQ11	
D10		PA0	BC0#/A0	MTIOC4A/ MTIOC6D/ TIOCA0/PO16/ CACREF	ET0_TX_EN/ RMII0_TXD_EN/ SSLA1-B		LCD_DATA8-B*1		
E1	XTAL	P37							
E2	VSS								
E3	RES#								
E4	TRST#	P34		MTIOC0A/ TMCI3/PO12/ POE10#	ET0_LINKSTA/ SCK6/SCK0			IRQ4	
E5		P41						IRQ9-DS	AN001
E6		PA2	A2	MTIOC7A/ PO18	RXD5/SMISO5/ SSCL5/SSLA3-B		LCD_DATA6-B*1		
E7		PA6	A6	MTIC5V/ MTCLKB/ TIOCA2/ TMCI3/PO22/ POE10#	ET0_EXOUT/ CTS5#/RTS5#/ SS5#/MOSIA-B		LCD_DATA2-B*1		
E8		PA4	A4	MTIC5U/ MTCLKA/ TIOCA1/ TMRI0/PO20	ET0_MDC/TXD5/ SMOSI5/SSDA5/ SSLA0-B		LCD_DATA4-B*1	IRQ5-DS	
E9		PA5	A5	MTIOC6B/ TIOCB1/PO21	ET0_LINKSTA/ RSPCKA-B		LCD_DATA3-B*1		
E10		PA3	A3	MTIOC0D/ MTCLKD/ TIOCD0/ TCLKB/PO19	ET0_MDIO/ RXD5/SMISO5/ SSCL5		LCD_DATA5-B*1	IRQ6-DS	
F1	EXTAL	P36							

3.2 External Address Space

The external address space is divided into CS areas (CS0 to CS7) and SDRAM area (SDCS). The CS areas are divided into up to eight areas (CS0 to CS7), each corresponding to the CSn# signal output from a CSn# (n = 0 to 7) pin.
Figure 3.2 shows the address ranges corresponding to the individual CS areas (CS0 to CS7) and SDRAM areas (SDCS) in on-chip ROM disabled extended mode.



Note 1. Reserved areas should not be accessed.
Note 2. This area is only included in products with at least 1.5 Mbytes of code flash memory.
Note 3. The CS0 area is disabled in on-chip ROM enabled extended mode.
In this mode, the address space for addresses above 1000 0000h is as shown in figure on this section, Memory Map in Each Operating Mode.

Figure 3.2 Correspondence between External Address Spaces and CS Areas (In On-Chip ROM Disabled Extended Mode)

Table 4.1 List of I/O Registers (Address Order) (15 / 61)

Address	Module Symbol	Register Name	Register Symbol	Number of Bits	Access Size	Number of Access Cycles		Related Function
						ICLK ≥ PCLK	ICLK < PCLK	
0008 814Ah	TPU3	Timer General Register B	TGRB	16	16	2, 3 PCLKB	2 ICLK	TPUa
0008 814Ch	TPU3	Timer General Register C	TGRC	16	16	2, 3 PCLKB	2 ICLK	TPUa
0008 814Eh	TPU3	Timer General Register D	TGRD	16	16	2, 3 PCLKB	2 ICLK	TPUa
0008 8150h	TPU4	Timer Control Register	TCR	8	8	2, 3 PCLKB	2 ICLK	TPUa
0008 8151h	TPU4	Timer Mode Register	TMDR	8	8	2, 3 PCLKB	2 ICLK	TPUa
0008 8152h	TPU4	Timer I/O Control Register	TIOR	8	8	2, 3 PCLKB	2 ICLK	TPUa
0008 8154h	TPU4	Timer Interrupt Enable Register	TIER	8	8	2, 3 PCLKB	2 ICLK	TPUa
0008 8155h	TPU4	Timer Status Register	TSR	8	8	2, 3 PCLKB	2 ICLK	TPUa
0008 8156h	TPU4	Timer Counter	TCNT	16	16	2, 3 PCLKB	2 ICLK	TPUa
0008 8158h	TPU4	Timer General Register A	TGRA	16	16	2, 3 PCLKB	2 ICLK	TPUa
0008 815Ah	TPU4	Timer General Register B	TGRB	16	16	2, 3 PCLKB	2 ICLK	TPUa
0008 8160h	TPU5	Timer Control Register	TCR	8	8	2, 3 PCLKB	2 ICLK	TPUa
0008 8161h	TPU5	Timer Mode Register	TMDR	8	8	2, 3 PCLKB	2 ICLK	TPUa
0008 8162h	TPU5	Timer I/O Control Register	TIOR	8	8	2, 3 PCLKB	2 ICLK	TPUa
0008 8164h	TPU5	Timer Interrupt Enable Register	TIER	8	8	2, 3 PCLKB	2 ICLK	TPUa
0008 8165h	TPU5	Timer Status Register	TSR	8	8	2, 3 PCLKB	2 ICLK	TPUa
0008 8166h	TPU5	Timer Counter	TCNT	16	16	2, 3 PCLKB	2 ICLK	TPUa
0008 8168h	TPU5	Timer General Register A	TGRA	16	16	2, 3 PCLKB	2 ICLK	TPUa
0008 816Ah	TPU5	Timer General Register B	TGRB	16	16	2, 3 PCLKB	2 ICLK	TPUa
0008 81E6h	PPG0	PPG Output Control Register	PCR	8	8	2, 3 PCLKB	2 ICLK	PPG
0008 81E7h	PPG0	PPG Output Mode Register	PMR	8	8	2, 3 PCLKB	2 ICLK	PPG
0008 81E8h	PPG0	Next Data Enable Registers H	NDERH	8	8	2, 3 PCLKB	2 ICLK	PPG
0008 81E9h	PPG0	Next Data Enable Registers L	NDERL	8	8	2, 3 PCLKB	2 ICLK	PPG
0008 81EAh	PPG0	Output Data Registers H	PODRH	8	8	2, 3 PCLKB	2 ICLK	PPG
0008 81EBh	PPG0	Output Data Registers L	PODRL	8	8	2, 3 PCLKB	2 ICLK	PPG
0008 81ECh	PPG0	Next Data Registers H*1	NDRH	8	8	2, 3 PCLKB	2 ICLK	PPG
0008 81EDh	PPG0	Next Data Registers L*2	NDRL	8	8	2, 3 PCLKB	2 ICLK	PPG
0008 81EEh	PPG0	Next Data Registers H*1	NDRH2	8	8	2, 3 PCLKB	2 ICLK	PPG
0008 81EFh	PPG0	Next Data Registers L*2	NDRL2	8	8	2, 3 PCLKB	2 ICLK	PPG
0008 81F0h	PPG1	PPG Trigger Select Register	PTRSLR	8	8	2, 3 PCLKB	2 ICLK	PPG
0008 81F6h	PPG1	PPG Output Control Register	PCR	8	8	2, 3 PCLKB	2 ICLK	PPG
0008 81F7h	PPG1	PPG Output Mode Register	PMR	8	8	2, 3 PCLKB	2 ICLK	PPG
0008 81F8h	PPG1	Next Data Enable Registers H	NDERH	8	8	2, 3 PCLKB	2 ICLK	PPG
0008 81F9h	PPG1	Next Data Enable Registers L	NDERL	8	8	2, 3 PCLKB	2 ICLK	PPG
0008 81FAh	PPG1	Output Data Registers H	PODRH	8	8	2, 3 PCLKB	2 ICLK	PPG
0008 81FBh	PPG1	Output Data Registers L	PODRL	8	8	2, 3 PCLKB	2 ICLK	PPG
0008 81FCh	PPG1	Next Data Registers H*3	NDRH	8	8	2, 3 PCLKB	2 ICLK	PPG
0008 81FDh	PPG1	Next Data Registers L*4	NDRL	8	8	2, 3 PCLKB	2 ICLK	PPG
0008 81FEh	PPG1	Next Data Registers H*3	NDRH2	8	8	2, 3 PCLKB	2 ICLK	PPG
0008 81FFh	PPG1	Next Data Registers L*4	NDRL2	8	8	2, 3 PCLKB	2 ICLK	PPG
0008 8200h	TMR0	Timer Control Register	TCR	8	8	2, 3 PCLKB	2 ICLK	TMR
0008 8201h	TMR1	Timer Control Register	TCR	8	8	2, 3 PCLKB	2 ICLK	TMR
0008 8202h	TMR0	Timer Control/Status Register	TCSR	8	8	2, 3 PCLKB	2 ICLK	TMR
0008 8203h	TMR1	Timer Control/Status Register	TCSR	8	8	2, 3 PCLKB	2 ICLK	TMR
0008 8204h	TMR0	Time Constant Register A	TCORA	8	8	2, 3 PCLKB	2 ICLK	TMR
0008 8204h	TMR01	Time Constant Register A	TCORA	16	16	2, 3 PCLKB	2 ICLK	TMR
0008 8205h	TMR1	Time Constant Register A	TCORA	8	8	2, 3 PCLKB	2 ICLK	TMR
0008 8206h	TMR0	Time Constant Register B	TCORB	8	8	2, 3 PCLKB	2 ICLK	TMR
0008 8206h	TMR01	Time Constant Register B	TCORB	16	16	2, 3 PCLKB	2 ICLK	TMR
0008 8207h	TMR1	Time Constant Register B	TCORB	8	8	2, 3 PCLKB	2 ICLK	TMR

Table 4.1 List of I/O Registers (Address Order) (27 / 61)

Address	Module Symbol	Register Name	Register Symbol	Number of Bits	Access Size	Number of Access Cycles		Related Function
						ICLK ≥ PCLK	ICLK < PCLK	
0008 A08Ah	SCI4	I²C Mode Register 2	SIMR2	8	8	2, 3 PCLKB	2 ICLK	SCIg, SCIh, SCIi
0008 A08Bh	SCI4	I²C Mode Register 3	SIMR3	8	8	2, 3 PCLKB	2 ICLK	SCIg, SCIh, SCIi
0008 A08Ch	SCI4	I²C Status Register	SISR	8	8	2, 3 PCLKB	2 ICLK	SCIg, SCIh, SCIi
0008 A08Dh	SCI4	SPI Mode Register	SPMR	8	8	2, 3 PCLKB	2 ICLK	SCIg, SCIh, SCIi
0008 A08Eh	SCI4	Transmit Data Register H	TDRH	8	8	2, 3 PCLKB	2 ICLK	SCIg, SCIh, SCIi
0008 A08Fh	SCI4	Transmit Data Register L	TDRL	8	8	2, 3 PCLKB	2 ICLK	SCIg, SCIh, SCIi
0008 A08Eh	SCI4	Transmit Data Register HL	TDRHL	16	16	4, 5 PCLKB	2 ICLK	SCIg, SCIh, SCIi
0008 A090h	SCI4	Receive Data Register H	RDRH	8	8	2, 3 PCLKB	2 ICLK	SCIg, SCIh, SCIi
0008 A091h	SCI4	Receive Data Register L	RDRL	8	8	2, 3 PCLKB	2 ICLK	SCIg, SCIh, SCIi
0008 A090h	SCI4	Receive Data Register HL	RDRHL	16	16	4, 5 PCLKB	2 ICLK	SCIg, SCIh, SCIi
0008 A092h	SCI4	Modulation Duty Register	MDDR	8	8	2, 3 PCLKB	2 ICLK	SCIg, SCIh, SCIi
0008 A0A0h	SCI5	Serial Mode Register	SMR	8	8	2, 3 PCLKB	2 ICLK	SCIg, SCIh, SCIi
0008 A0A1h	SCI5	Bit Rate Register	BRR	8	8	2, 3 PCLKB	2 ICLK	SCIg, SCIh, SCIi
0008 A0A2h	SCI5	Serial Control Register	SCR	8	8	2, 3 PCLKB	2 ICLK	SCIg, SCIh, SCIi
0008 A0A3h	SCI5	Transmit Data Register	TDR	8	8	2, 3 PCLKB	2 ICLK	SCIg, SCIh, SCIi
0008 A0A4h	SCI5	Serial Status Register	SSR	8	8	2, 3 PCLKB	2 ICLK	SCIg, SCIh, SCIi
0008 A0A5h	SCI5	Receive Data Register	RDR	8	8	2, 3 PCLKB	2 ICLK	SCIg, SCIh, SCIi
0008 A0A6h	SMCI5	Smart Card Mode Register	SCMR	8	8	2, 3 PCLKB	2 ICLK	SCIg, SCIh, SCIi
0008 A0A7h	SCI5	Serial Extended Mode Register	SEMR	8	8	2, 3 PCLKB	2 ICLK	SCIg, SCIh, SCIi
0008 A0A8h	SCI5	Noise Filter Setting Register	SNFR	8	8	2, 3 PCLKB	2 ICLK	SCIg, SCIh, SCIi
0008 A0A9h	SCI5	I²C Mode Register 1	SIMR1	8	8	2, 3 PCLKB	2 ICLK	SCIg, SCIh, SCIi
0008 A0AAh	SCI5	I²C Mode Register 2	SIMR2	8	8	2, 3 PCLKB	2 ICLK	SCIg, SCIh, SCIi
0008 A0ABh	SCI5	I²C Mode Register 3	SIMR3	8	8	2, 3 PCLKB	2 ICLK	SCIg, SCIh, SCIi

Table 4.1 List of I/O Registers (Address Order) (42 / 61)

Address	Module Symbol	Register Name	Register Symbol	Number of Bits	Access Size	Number of Access Cycles		Related Function
						ICLK ≥ PCLK	ICLK < PCLK	
0008 C282h	SYSTEM	Deep Standby Interrupt Enable Register 0	DPSIER0	8	8	4, 5 PCLKB	2, 3 ICLK	Low Power Consumption
0008 C283h	SYSTEM	Deep Standby Interrupt Enable Register 1	DPSIER1	8	8	4, 5 PCLKB	2, 3 ICLK	Low Power Consumption
0008 C284h	SYSTEM	Deep Standby Interrupt Enable Register 2	DPSIER2	8	8	4, 5 PCLKB	2, 3 ICLK	Low Power Consumption
0008 C285h	SYSTEM	Deep Standby Interrupt Enable Register 3	DPSIER3	8	8	4, 5 PCLKB	2, 3 ICLK	Low Power Consumption
0008 C286h	SYSTEM	Deep Standby Interrupt Flag Register 0	DPSIFR0	8	8	4, 5 PCLKB	2, 3 ICLK	Low Power Consumption
0008 C287h	SYSTEM	Deep Standby Interrupt Flag Register 1	DPSIFR1	8	8	4, 5 PCLKB	2, 3 ICLK	Low Power Consumption
0008 C288h	SYSTEM	Deep Standby Interrupt Flag Register 2	DPSIFR2	8	8	4, 5 PCLKB	2, 3 ICLK	Low Power Consumption
0008 C289h	SYSTEM	Deep Standby Interrupt Flag Register 3	DPSIFR3	8	8	4, 5 PCLKB	2, 3 ICLK	Low Power Consumption
0008 C28Ah	SYSTEM	Deep Standby Interrupt Edge Register 0	DPSIEGR0	8	8	4, 5 PCLKB	2, 3 ICLK	Low Power Consumption
0008 C28Bh	SYSTEM	Deep Standby Interrupt Edge Register 1	DPSIEGR1	8	8	4, 5 PCLKB	2, 3 ICLK	Low Power Consumption
0008 C28Ch	SYSTEM	Deep Standby Interrupt Edge Register 2	DPSIEGR2	8	8	4, 5 PCLKB	2, 3 ICLK	Low Power Consumption
0008 C28Dh	SYSTEM	Deep Standby Interrupt Edge Register 3	DPSIEGR3	8	8	4, 5 PCLKB	2, 3 ICLK	Low Power Consumption
0008 C290h	SYSTEM	Reset Status Register 0	RSTSR0	8	8	4, 5 PCLKB	2, 3 ICLK	Resets
0008 C291h	SYSTEM	Reset Status Register 1	RSTSR1	8	8	4, 5 PCLKB	2, 3 ICLK	Resets
0008 C293h	SYSTEM	Main Clock Oscillator Forced Oscillation Control Register	MOFCR	8	8	4, 5 PCLKB	2, 3 ICLK	Clock Generation Circuit
0008 C294h	SYSTEM	High-Speed On-Chip Oscillator Power Supply Control Register	HOCOPCR	8	8	4, 5 PCLKB	2, 3 ICLK	Clock Generation Circuit
0008 C296h	FLASH	Flash P/E Protect Register	FWEPROR	8	8	2 ICLK		Flash
0008 C297h	SYSTEM	Voltage Monitoring Circuit Control Register	LVCMPCR	8	8	4, 5 PCLKB	2, 3 ICLK	LVDA
0008 C298h	SYSTEM	Voltage Detection Level Select Register	LVDLVLR	8	8	4, 5 PCLKB	2, 3 ICLK	LVDA
0008 C29Ah	SYSTEM	Voltage Monitoring 1 Circuit Control Register 0	LVD1CR0	8	8	4, 5 PCLKB	2, 3 ICLK	LVDA
0008 C29Bh	SYSTEM	Voltage Monitoring 2 Circuit Control Register 0	LVD2CR0	8	8	4, 5 PCLKB	2, 3 ICLK	LVDA

Table 5.4 DC Characteristics (2)

Conditions: VCC = AVCC0 = AVCC1 = VCC_USB = V_{BATT} = 2.7 to 3.6 V, 2.7 V ≤ VREFH0 ≤ AVCC0,
VSS = AVSS0 = AVSS1 = VREFL0 = VSS_USB = 0 V,
$T_a = T_{opr}$

Item		Symbol	Min.	Typ.	Max.	Unit	Test Conditions
Output high voltage	All output pins	V_{OH}	VCC – 0.5	—	—	V	I_{OH} = –1 mA
Output low voltage	All output pins (except for RIIC pins and ETHERC output pin)	V_{OL}	—	—	0.5	V	I_{OL} = 1.0 mA
	RIIC output pin		—	—	0.4		I_{OL} = 3.0 mA
			—	—	0.6		I_{OL} = 6.0 mA
	RIIC output pin (only P12 and P13 in channel 0)	V_{OL}	—	—	0.4	V	I_{OL} = 15.0 mA (ICFER.FMPE = 1)
			—	0.4	—		I_{OL} = 20.0 mA (ICFER.FMPE = 1)
	ETHERC output pin	V_{OL}	—	—	0.4	V	I_{OL} = 1.0 mA
Input leakage current	RES#, MD pin, EMLE*1, BSCANP*1, NMI	$\lvert I_{in} \rvert$	—	—	1.0	μA	V_{in} = 0 V V_{in} = VCC
Three-state leakage current (off state)	Other than ports for 5 V tolerant	$\lvert I_{TSI} \rvert$	—	—	1.0	μA	V_{in} = 0 V V_{in} = VCC
	Ports for 5 V tolerant		—	—	5.0		V_{in} = 0 V V_{in} = 5.5 V
Input pull-up MOS current	Other than P35	I_p	–300	—	–10	μA	VCC = 2.7 to 3.6 V V_{in} = 0 V
Input pull-down MOS current	EMLE, BSCANP	I_p	10	—	300	μA	V_{in} = VCC
Input capacitance	All input pins (except for ports 03, 05, 12, 13, 16, 17, 20, 21, EMLE, BSCANP, USB0_DP, and USB0_DM)	C_{in}	—	—	8	pF	Vbias = 0 V Vamp = 20 mV f = 1 MHz T_a = 25°C
	Ports 03, 05, 12, 13, 16, 17, 20, 21, EMLE, BSCANP, USB0_DP, and USB0_DM		—	—	16		

Note 1. The input leakage current value at the EMLE and BSCANP pins are only when V_{in} = 0 V.

Table 5.8 Permissible Output Currents

Conditions: VCC = AVCC0 = AVCC1 = VCC_USB = V_{BATT} = 2.7 to 3.6 V, 2.7 V ≤ VREFH0 ≤ AVCC0,
VSS = AVSS0 = AVSS1 = VREFL0 = VSS_USB = 0 V,
$T_a = T_{opr}$

Item			Symbol	Min.	Typ.	Max.	Unit
Permissible output low current (average value per pin)	All output pins*1	Normal drive	I_{OL}	—	—	2.0	mA
	All output pins*2	High drive	I_{OL}	—	—	3.8	mA
	All output pins*3	High-speed interface high-drive	I_{OL}	—	—	7.5	mA
Permissible output low current (max. value per pin)	All output pins*1	Normal drive	I_{OL}	—	—	4.0	mA
	All output pins*2	High drive	I_{OL}	—	—	7.6	mA
	All output pins*3	High-speed interface high-drive	I_{OL}	—	—	15	mA
Permissible output low current (total)	Total of all output pins		ΣI_{OL}	—	—	80	mA
Permissible output high current (average value per pin)	All output pins*1	Normal drive	I_{OH}	—	—	–2.0	mA
	All output pins*2	High drive	I_{OH}	—	—	–3.8	mA
	All output pins*3	High-speed interface high-drive	I_{OH}	—	—	–7.5	mA
Permissible output high current (max. value per pin)	All output pins*1	Normal drive	I_{OH}	—	—	–4.0	mA
	All output pins*2	High drive	I_{OH}	—	—	–7.6	mA
	All output pins*3	High-speed interface high-drive	I_{OH}	—	—	–15	mA
Permissible output high current (total)	Total of all output pins		ΣI_{OH}	—	—	–80	mA

Caution: To protect the LSI's reliability, the output current values should not exceed the values in this table.

Note 1. This is the value when normal driving ability is set with a pin for which normal driving ability is selectable.

Note 2. This is the value when high driving ability is set with a pin for which normal driving ability is selectable or the value of the pin to which high driving ability is fixed.

Note 3. This is the value when high-speed interface high-driving ability is set with a pin for which high-speed interface high-driving ability is selectable.

Table 5.9 Heat Resistance Value (Reference)

Item	Package	Symbol	Max.	Unit	Test Conditions
Heat resistance	176-pin LFQFP (PLQP0176KB-A)	θ_{ja}	48.0	°C/W	JESD51-2 and JESD51-7 compliant
	144-pin LFQFP (PLQP0144KA-B)		50.9		
	100-pin LFQFP (PLQP0100KB-B)		52.5		
	177-pin TFLGA (PTLG0177KA-A)		36.3		JESD51-2 and JESD51-9 compliant
	176-pin LFBGA (PLBG0176GA-A)		35.4		
	145-pin TFLGA (PTLG0145KA-A)		34.6		
	100-pin TFLGA (PTLG0100JA-A)		34.1		
	176-pin LFQFP (PLQP0176KB-A)	Ψ_{jt}	1.0	°C/W	JESD51-2 and JESD51-7 compliant
	144-pin LFQFP (PLQP0144KA-B)		1.5		
	100-pin LFQFP (PLQP0100KB-B)		1.5		
	177-pin TFLGA (PTLG0177KA-A)		0.3		JESD51-2 and JESD51-9 compliant
	176-pin LFBGA (PLBG0176GA-A)		0.3		
	145-pin TFLGA (PTLG0145KA-A)		0.4		
	100-pin TFLGA (PTLG0100JA-A)		0.4		

Note: The values are reference values when the 4-layer board is used. Heat resistance depends on the number of layers or size of the board. For details, refer to the JEDEC standards.

Table 5.17 LOCO and IWDT-Dedicated Low-Speed Clock Timing

Conditions: VCC = AVCC0 = AVCC1 = VCC_USB = V_{BATT} = 2.7 to 3.6 V, 2.7 V ≤ VREFH0 ≤ AVCC0,
VSS = AVSS0 = AVSS1 = VREFL0 = VSS_USB = 0 V,
$T_a = T_{opr}$

Item	Symbol	Min.	Typ.	Max.	Unit	Test Conditions
LOCO clock cycle time	t_{Lcyc}	4.63	4.16	3.78	µs	
LOCO clock oscillation frequency	f_{LOCO}	216	240	264	kHz	
LOCO clock oscillation stabilization wait time	t_{LOCOWT}	—	—	44	µs	Figure 5.6
IWDT-dedicated low-speed clock cycle time	t_{ILcyc}	9.26	8.33	7.57	µs	
IWDT-dedicated low-speed clock oscillation frequency	f_{ILOCO}	108	120	132	kHz	
IWDT-dedicated low-speed clock oscillation stabilization wait time	$t_{ILOCOWT}$	—	142	190	µs	Figure 5.7

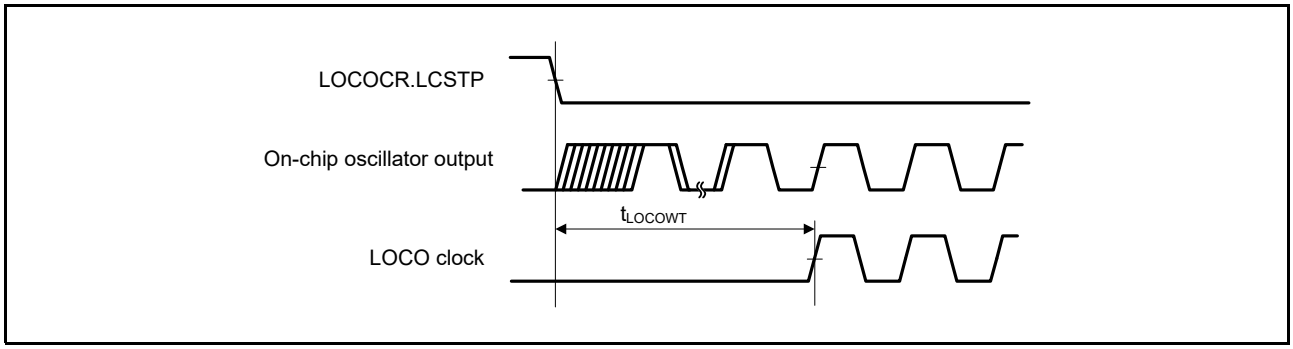


Figure 5.6 LOCO Clock Oscillation Start Timing

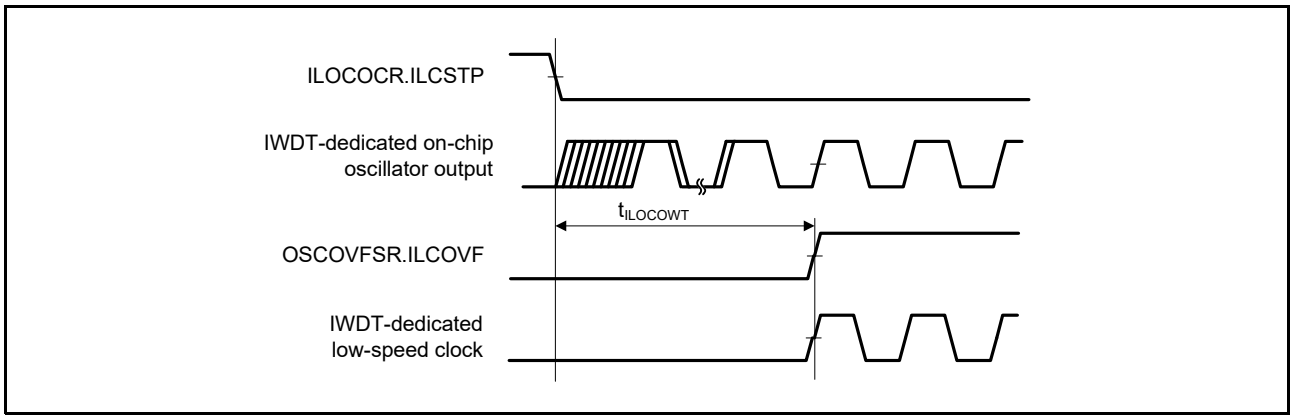


Figure 5.7 IWDT-dedicated Low-Speed Clock Oscillation Start Timing

Table 5.27 TPU Timing

Conditions: VCC = AVCC0 = AVCC1 = VCC_USB = V_{BATT} = 2.7 to 3.6 V, 2.7 V ≤ VREFH0 ≤ AVCC0,
VSS = AVSS0 = AVSS1 = VREFL0 = VSS_USB = 0 V,
PCLKA = 8 to 120 MHz, PCLKB = 8 to 60 MHz, $T_a = T_{opr}$,
Output load conditions: V_{OH} = VCC × 0.5, V_{OL} = VCC × 0.5, C = 30 pF,
High-drive output is selected by the driving ability control register.

Item			Symbol	Min.	Max.	Unit*1	Test Conditions
TPU	Input capture input pulse width	Single-edge setting	t_{TICW}	1.5	—	t_{PBcyc}	Figure 5.34
		Both-edge setting		2.5	—		
	Timer clock pulse width	Single-edge setting	t_{TCKWH}, t_{TCKWL}	1.5	—	t_{PBcyc}	Figure 5.35
		Both-edge setting		2.5	—		
		Phase counting mode		2.5	—		

Note 1. t_{PBcyc}: PCLKB cycle

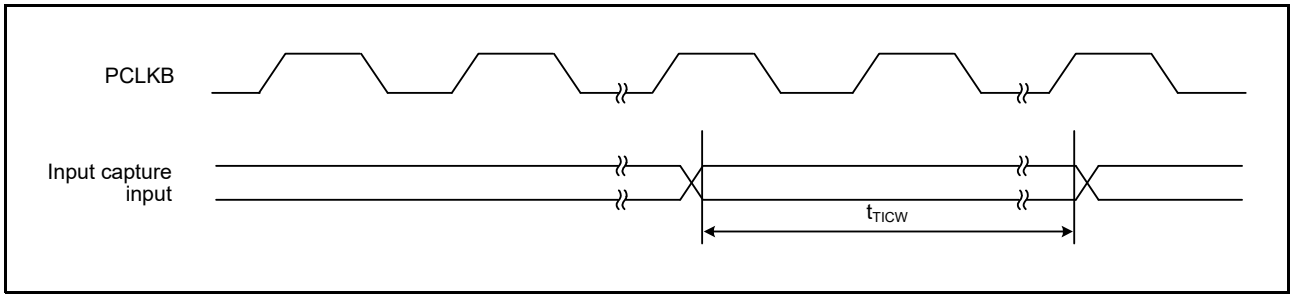


Figure 5.34 TPU Input Capture Input Timing

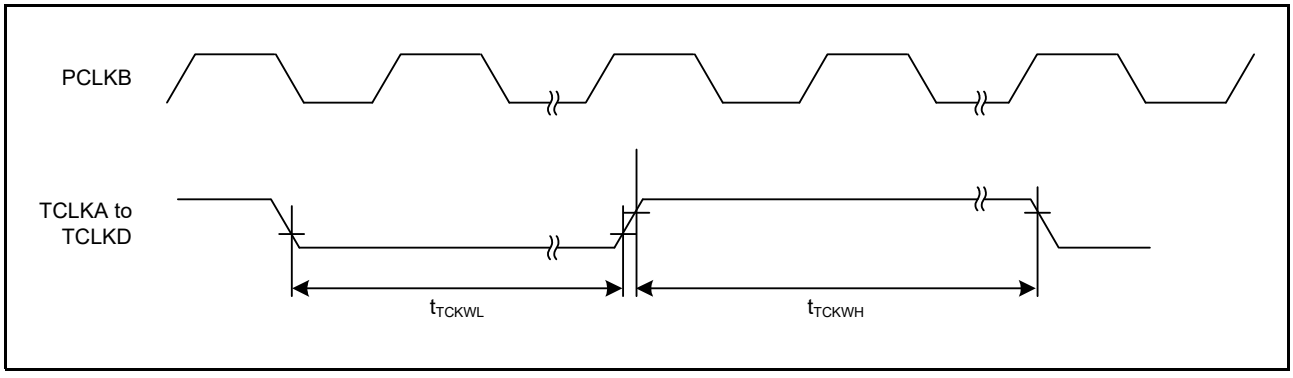


Figure 5.35 TPU Clock Input Timing

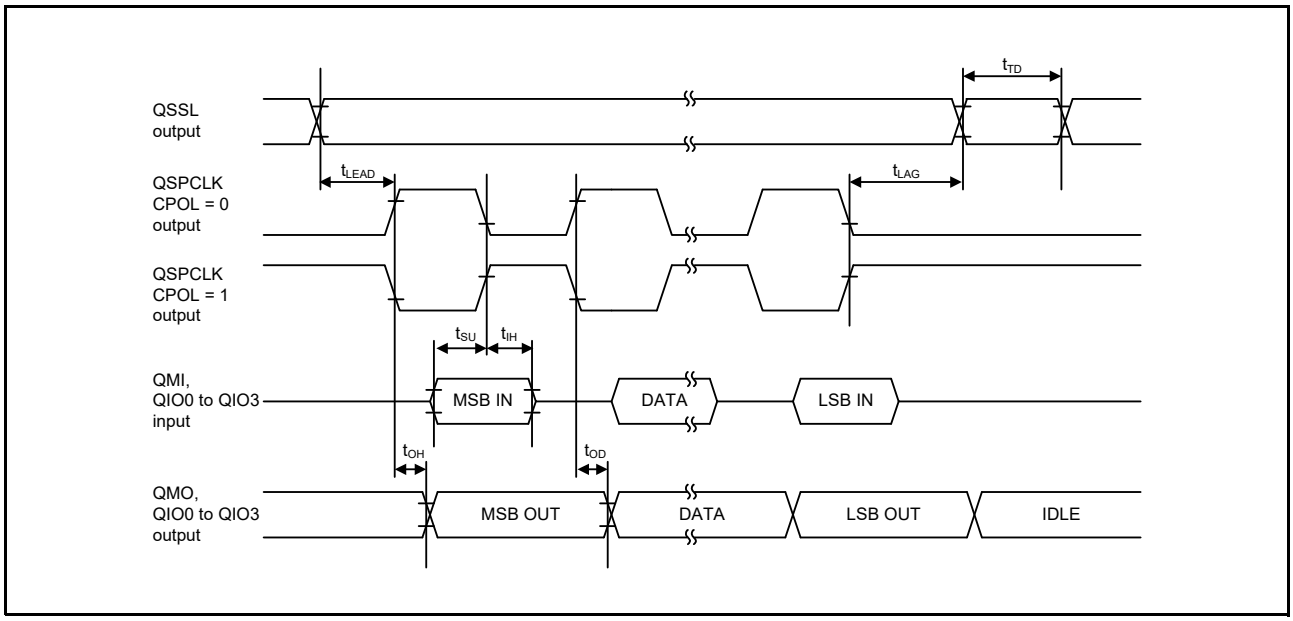


Figure 5.53 Transmit/Receive Timing (CPHA = 1)

5.11 Flash Memory Characteristics

Table 5.54 Code Flash Memory Characteristics

Conditions: VCC = AVCC0 = AVCC1 = VCC_USB = V_{BATT} = 2.7 to 3.6 V, 2.7 V ≤ VREFH0 ≤ AVCC0,
VSS = AVSS0 = AVSS1 = VREFL0 = VSS_USB = 0 V,
Temperature range for programming/erasure: $T_a = T_{opr}$

Item		Symbol	FCLK = 4 MHz			FCLK = 15 MHz			20 MHz ≤ FCLK ≤ 60 MHz			Unit
			Min.	Typ.	Max.	Min.	Typ.	Max.	Min.	Typ.	Max.	
Programming time N_{PEC} ≤ 100 times	128 bytes	t_{P128}	—	0.75	13.2	—	0.38	6.6	—	0.34	6	ms
	8 Kbytes	t_{P8K}	—	49	176	—	25	88	—	22	80	ms
	32 Kbytes	t_{P32K}	—	194	704	—	97	352	—	88	320	ms
Programming time N_{PEC} > 100 times	128 bytes	t_{P128}	—	0.91	15.8	—	0.46	8	—	0.41	7.2	ms
	8 Kbytes	t_{P8K}	—	60	212	—	30	106	—	27	96	ms
	32 Kbytes	t_{P32K}	—	234	848	—	117	424	—	106	384	ms
Erasure time N_{PEC} ≤ 100 times	8 Kbytes	t_{E8K}	—	78	216	—	48	132	—	43	120	ms
	32 Kbytes	t_{E32K}	—	283	864	—	173	528	—	157	480	ms
Erasure time N_{PEC} > 100 times	8 Kbytes	t_{E8K}	—	94	260	—	58	158	—	52	144	ms
	32 Kbytes	t_{E32K}	—	341	1040	—	208	632	—	189	576	ms
Reprogramming/erasure cycle*1		N_{PEC}	10000 *2	—	—	10000 *2	—	—	10000 *2	—	—	Times
Suspend delay time during programming		t_{SPD}	—	—	264	—	—	132	—	—	120	µs
First suspend delay time during erasing (in suspend priority mode)		t_{SESD1}	—	—	216	—	—	132	—	—	120	µs
Second suspend delay time during erasure (in suspend priority mode)		t_{SESD2}	—	—	1.7	—	—	1.7	—	—	1.7	ms
Suspend delay time during erasure (in erasure priority mode)		t_{SEED}	—	—	1.7	—	—	1.7	—	—	1.7	ms
Forced stop command		t_{FD}	—	—	32	—	—	22	—	—	20	µs
Data hold time*3		t_{DRP}	10	—	—	10	—	—	10	—	—	Year

Note 1. Definition of reprogram/erase cycle:
The reprogram/erase cycle is the number of erasing for each block. When the reprogram/erase cycle is n times (n = 1000), erasing can be performed n times for each block. For instance, when 128-byte programming is performed 64 times for different addresses in 8-Kbyte block and then the entire block is erased, the reprogram/erase cycle is counted as one. However, programming the same address for several times as one erasing is not enabled (overwriting is prohibited).

Note 2. This is the minimum number of times to guarantee all the characteristics after reprogramming (guaranteed range is from 1 to the value of the minimum value).

Note 3. This shows the characteristics when reprogramming is performed within the specified range, including the minimum value.

5.12 Boundary Scan

Table 5.56 Boundary Scan Characteristics

Conditions: VCC = AVCC0 = AVCC1 = VCC_USB = V_{BATT} = 2.7 to 3.6 V, 2.7 V ≤ VREFH0 ≤ AVCC0,
VSS = AVSS0 = AVSS1 = VREFL0 = VSS_USB = 0 V,
$T_a = T_{opr}$,
Output load conditions: V_{OH} = VCC × 0.5, V_{OL} = VCC × 0.5, C = 30 pF,
High-drive output is selected by the driving ability control register.

Item	Symbol	Min.	Typ.	Max.	Unit	Test Conditions
TCK clock cycle time	t_{TCKcyc}	100	—	—	ns	Figure 5.83
TCK clock high pulse width	t_{TCKH}	45	—	—	ns	
TCK clock low pulse width	t_{TCKL}	45	—	—	ns	
TCK clock rise time	t_{TCKr}	—	—	5	ns	
TCK clock fall time	t_{TCKf}	—	—	5	ns	
TRST# pulse width	t_{TRSTW}	20	—	—	t_{TCKcyc}	Figure 5.84
TMS setup time	t_{TMSS}	20	—	—	ns	Figure 5.85
TMS hold time	t_{TMSH}	20	—	—	ns	
TDI setup time	t_{TDIS}	20	—	—	ns	
TDI hold time	t_{TDIH}	20	—	—	ns	
TDO data delay time	t_{TDOD}	—	—	40	ns	

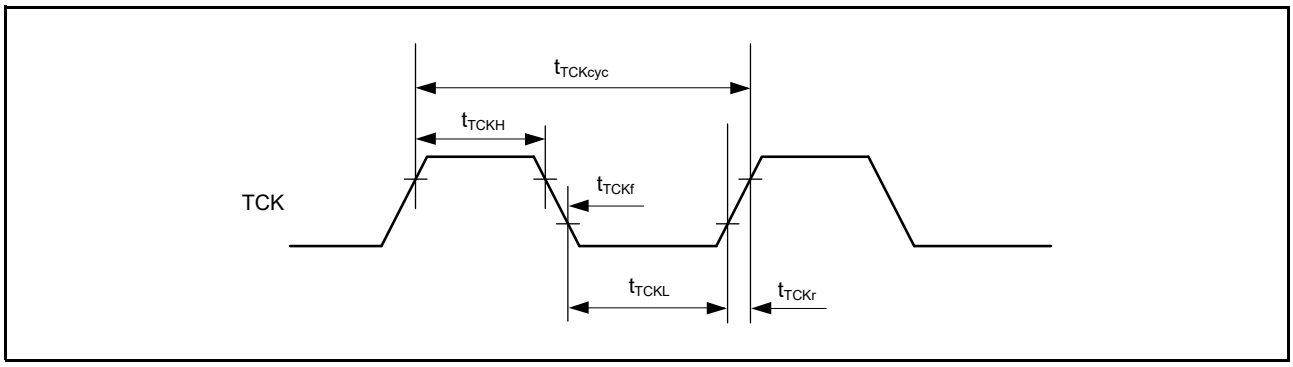


Figure 5.83 Boundary Scan TCK Timing

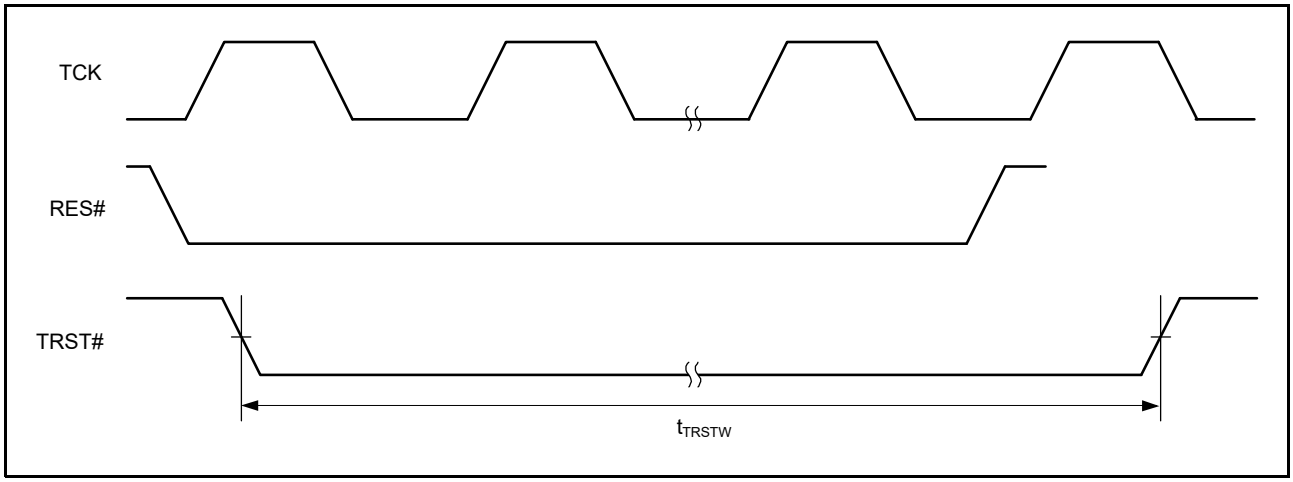
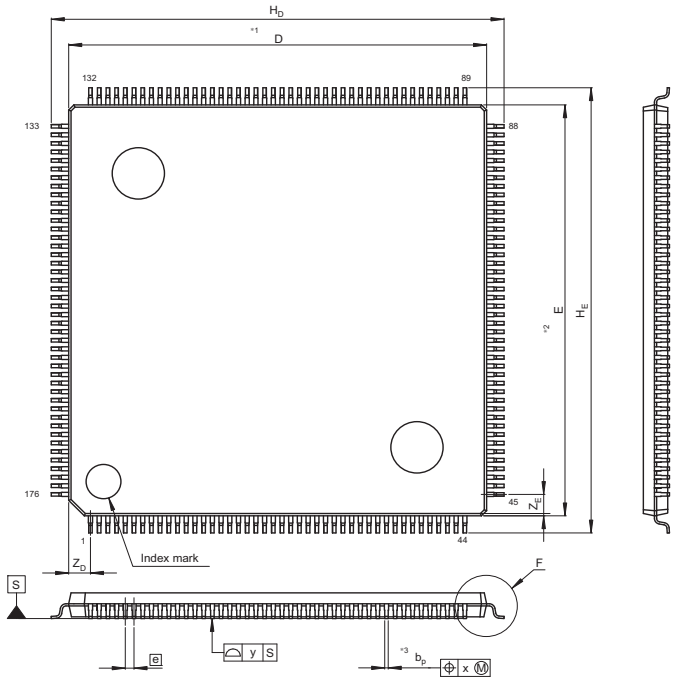
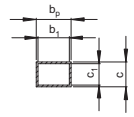


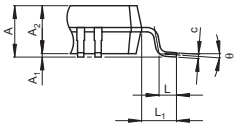
Figure 5.84 Boundary Scan TRST# Timing

JEITA Package Code	RENESAS Code	Previous Code	MASS[Typ.]
P-LFQFP176-24x24-0.50	PLQP0176KB-A	176P6Q-A/FP-176E/FP-176EV	1.8g





Terminal cross section



Detail F

NOTE)
1. DIMENSIONS "*1" AND "*2" DO NOT INCLUDE MOLD FLASH.
2. DIMENSION "*3" DOES NOT INCLUDE TRIM OFFSET.

Reference Symbol	Dimension in Millimeters		
	Min	Nom	Max
D	23.9	24.0	24.1
E	23.9	24.0	24.1
A_2	—	1.4	—
H_D	25.8	26.0	26.2
H_E	25.8	26.0	26.2
A	—	—	1.7
A_1	0.05	0.1	0.15
b_p	0.15	0.20	0.25
b_1	—	0.18	—
c	0.09	0.145	0.20
c_1	—	0.125	—
θ	0°	—	8°
e	—	0.5	—
x	—	—	0.08
y	—	—	0.10
Z_D	—	1.25	—
Z_E	—	1.25	—
L	0.35	0.5	0.65
L_1	—	1.0	—

Figure C 176-Pin LFQFP (PLQP0176KB-A)